

ACUROS[®] CQD[®] 1920L USB3 eSWIR Camera

ACUROS-1920-USB3-004

The ACUROS CQD L-Series extended SWIR (eSWIR) cameras feature large sensor area, low angular dependence and a long working distance for highly divergent emitters and collimated beams. ACUROS cameras deliver high resolution, high dynamic range and very high detectivity imaging from 400 nm to 2000 nm. The L-Series cameras are designed for use exclusively in laser beam diagnostics, laser beam imaging and laser alignment applications by mitigating interference fringing sources.

SPECIFICATIONS

Table 1. ELECTRO-OPTICAL SPECIFICATIONS

Parameter	Value/Description
Sensor	ACUROS CQD sensor
Temperature Stabilization	Single-stage thermo-electric cooler
Sensor Array Format	1920 x 1080
Resolution	2.07 MP (megapixel)
Spectral Band	400–2000 nm
Array Size	28.8 mm x 16.2 mm, 33 mm diagonal
Pixel Pitch	15 μm x 15 μm
Max Frame Rate at Full Resolution	58 fps (8, 10, 12, 14 bit)
Pixel Operability	99.9% typical, 99.75% min
Bit Depth	8, 10, 12, 14 bit selectable
Integration Type	Snapshot global shutter
Trigger	External TTL
Integration Time	100 μs to 4 s
Dynamic Range	65 dB typical
Windowing & Windowing Frame Rate	Array centered. Scales inversely to window size
Laser Beam Fringeless Operation	Yes
Binning Arrays	2 x 2, 4 x 4
Non-uniformity Correction	2-point non-uniformity correction
Temporal Dark Noise	80/70/65 e ⁻ typical (high gain)
Quantum Efficiency	See typical QE curve (Figure 4)



ORDERING INFORMATION

Part Number
ACUROS-1920-USB3-004

Features

- Large Sensor Size
- Short Working Distance for Highly Divergent Beams
- Low Angular Dependence
- Dynamic Range up to 70 dB
- 2.1 MP Resolution
- Linear Photoresponse
- TEC Cooling
- Low Noise
- USB3 Vision
- Visible-eSWIR

Applications

- Laser beam Diagnostics
- Laser Beam Imaging
- Laser Alignment

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Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

Parameter	Value/Description
Operating Case Temperature	-20 °C to +55 °C
Power Consumption	6.5–12 W depending on TEC settings
Power Supply Voltage	6–16 V dc
Regulatory Compliance	CE mark

Table 3. MECHANICAL SPECIFICATIONS

Parameter	Value/Description
Dimensions Excluding Lens	6.1 x 6.1 x 9.1 cm (C-mount)
Weight Excluding Lens	495 grams with (C-mount) adapter
Lens Mounts	Standard mount (C-mount). Inquire for other options.
Power Connector	Hirose 12-pin, HR10A-10R-12PB (71)
Trigger Connector	BNC

Table 4. SOFTWARE AND USER INTERFACE

Parameter	Value/Description
Software Development Kit	Windows GUI & Pleora eBUS SDK (Linux, Windows, macOS)
GenICam Compliance	Yes
Interface	USB3 Vision

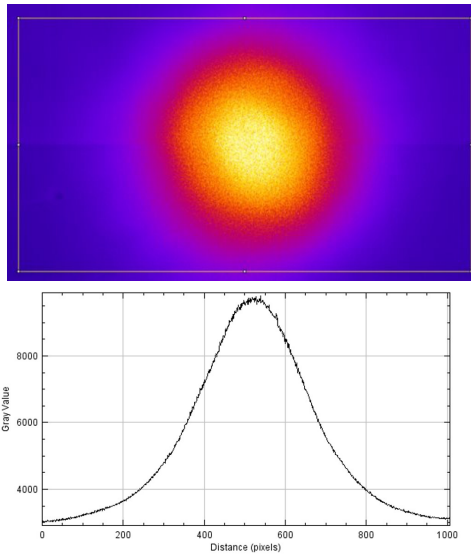


Figure 1. F-mount and M-42 Lens Mounts



Figure 2. USB Vision Interface

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1550 nm Laser image and corresponding line file (false color added post image)

Figure 3. ACUROS CQD SWIR Camera Image of Laser

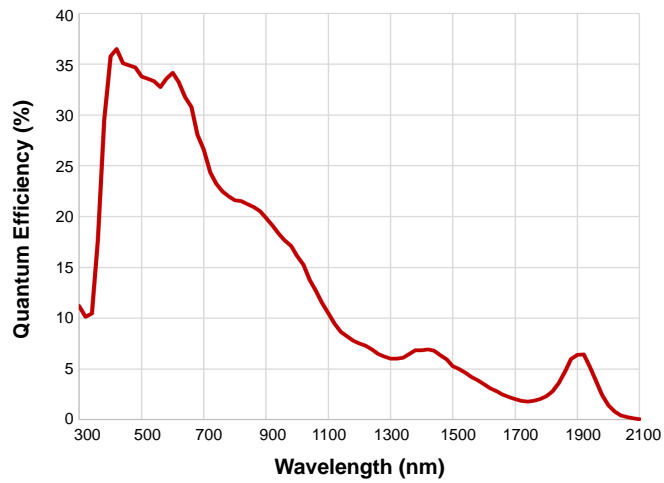
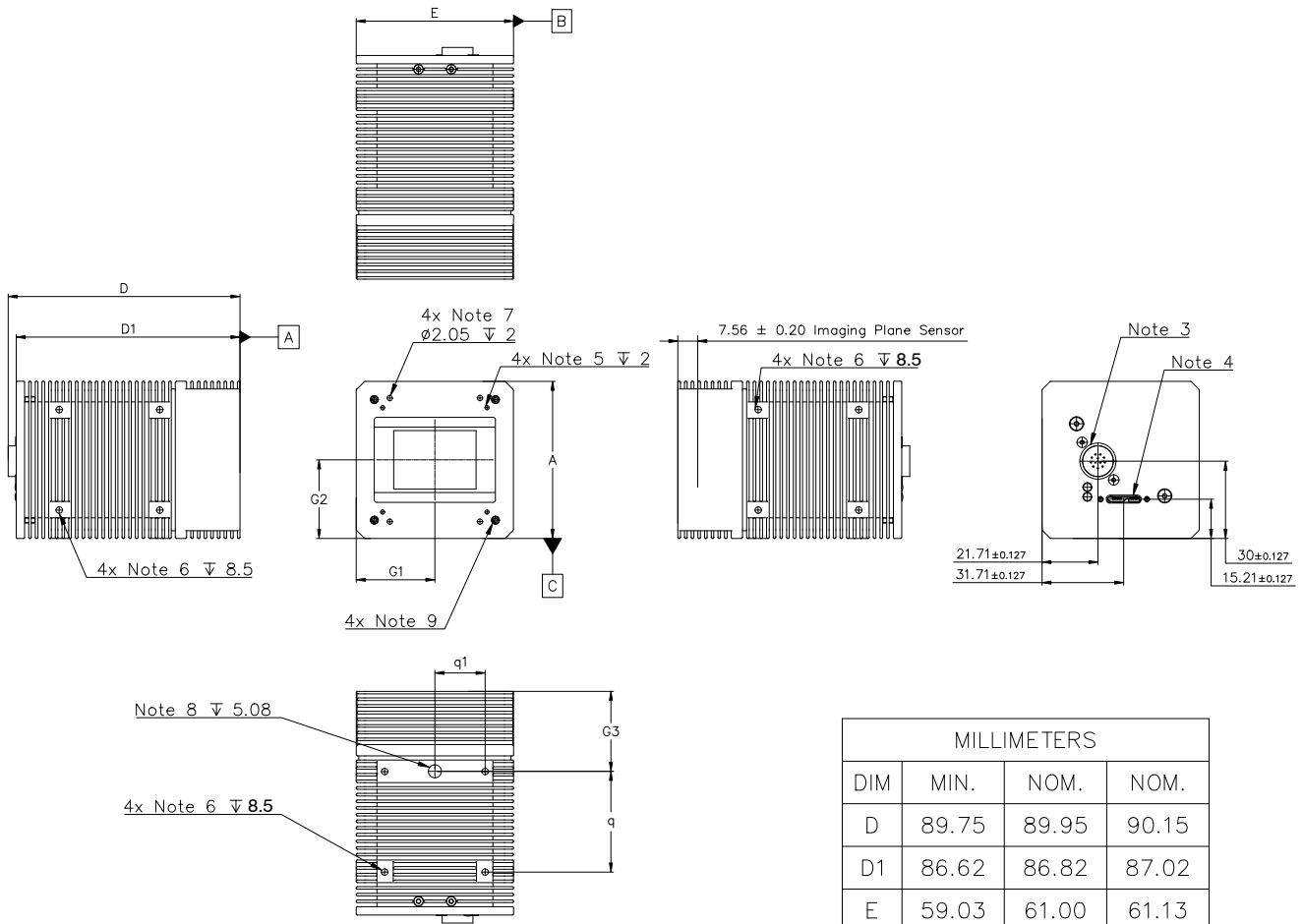


Figure 4. Typical QE Performance

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MILLIMETERS			
DIM	MIN.	NOM.	NOM.
D	89.75	89.95	90.15
D1	86.62	86.82	87.02
E	59.03	61.00	61.13
A	59.03	61.00	61.13
G1	30.37	30.50	30.63
G2	30.37	30.50	30.63
G3	30.84	31.04	31.24
q	38.98	39.11	39.24
q1	19.37	19.50	19.63

- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
 2. CONTROLLING DIMENSION: MILLIMETER
 3. HIROSE 12 PIN CONNECTOR
 4. USB 3.0 Micro-B
 5. M2x0.4 ∇ 2
 6. M3X0.5 DEPTH ∇ 8.5
 7. REGISTRATION HOLES \varnothing 2.05
 8. 1/4-20 UNC DEPTH ∇ 5.08
 9. M2X6

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